

**PowerMOS transistor**

**PHD5N20E**

**GENERAL DESCRIPTION**

N-channel enhancement mode field-effect power transistor in a plastic envelope suitable for surface mounting featuring high avalanche energy capability, stable blocking voltage, fast switching and high thermal cycling performance with low thermal resistance. Intended for use in Switched Mode Power Supplies (SMPS), motor control circuits and general purpose switching applications.

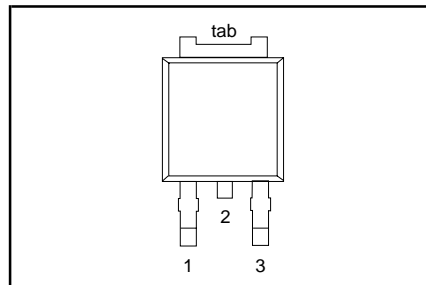
**QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	UNIT
$V_{DS}$	Drain-source voltage	200	V
$I_D$	Drain current (DC)	5.0	A
$P_{tot}$	Total power dissipation	60	W
$R_{DS(ON)}$	Drain-source on-state resistance	0.9	$\Omega$

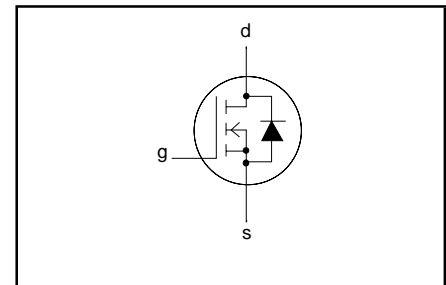
**PINNING - SOT428**

PIN	DESCRIPTION
1	gate
2	drain
3	source
tab	drain

**PIN CONFIGURATION**



**SYMBOL**



**LIMITING VALUES**

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
$I_D$	Continuous drain current	$T_{mb} = 25\text{ }^\circ\text{C}; V_{GS} = 10\text{ V}$ $T_{mb} = 100\text{ }^\circ\text{C}; V_{GS} = 10\text{ V}$	-	5	A
$I_{DM}$	Pulsed drain current	$T_{mb} = 25\text{ }^\circ\text{C}$	-	3.5	A
$P_D$	Total dissipation	$T_{mb} = 25\text{ }^\circ\text{C}$	-	20	W
$\Delta P_D / \Delta T_{mb}$	Linear derating factor	$T_{mb} = 25\text{ }^\circ\text{C}$ $T_{mb} > 25\text{ }^\circ\text{C}$	-	60	W
$V_{GS}$	Gate-source voltage		-	0.4	W/K
$E_{AS}$	Single pulse avalanche energy	$V_{DD} \leq 50\text{ V};$ starting $T_j = 25\text{ }^\circ\text{C}; R_{GS} = 50\text{ }\Omega;$ $V_{GS} = 10\text{ V}$	-	$\pm 30$	V
$I_{AS}$	Peak avalanche current	$V_{DD} \leq 50\text{ V};$ starting $T_j = 25\text{ }^\circ\text{C}; R_{GS} = 50\text{ }\Omega;$ $V_{GS} = 10\text{ V}$	-	40	mJ
$T_j, T_{stg}$	Operating junction and storage temperature range		-55	5	A
				175	$^\circ\text{C}$

**THERMAL RESISTANCES**

SYMBOL	PARAMETER	CONDITIONS	TYP.	MAX.	UNIT
$R_{th\ j-mb}$	Thermal resistance junction to mounting base		-	2.5	K/W
$R_{th\ j-a}$	Thermal resistance junction to ambient	pcb mounted, minimum footprint	50	-	K/W

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**ELECTRICAL CHARACTERISTICS** $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified

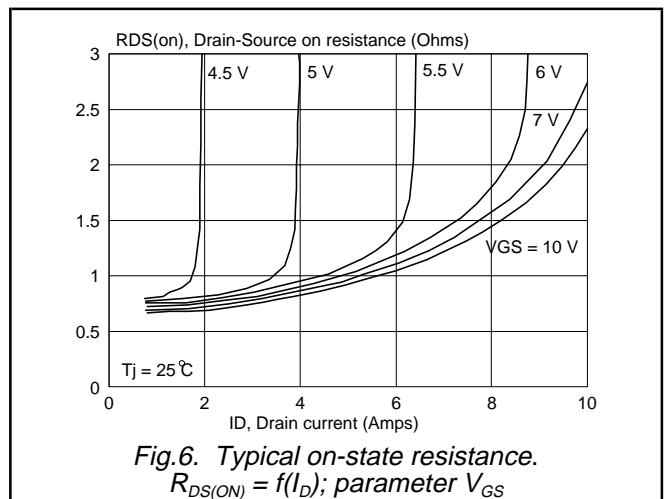
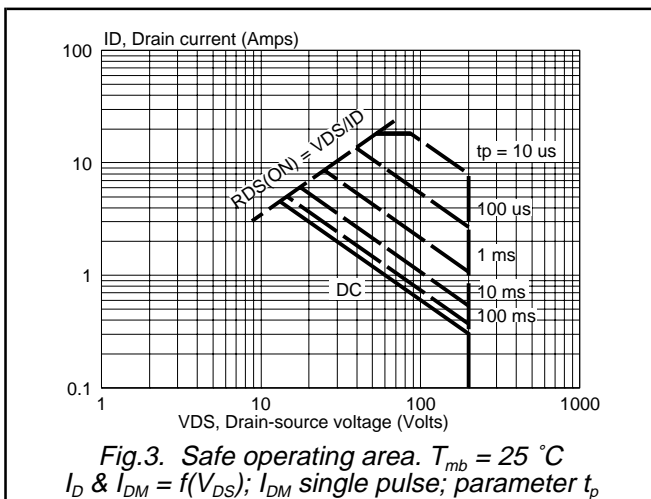
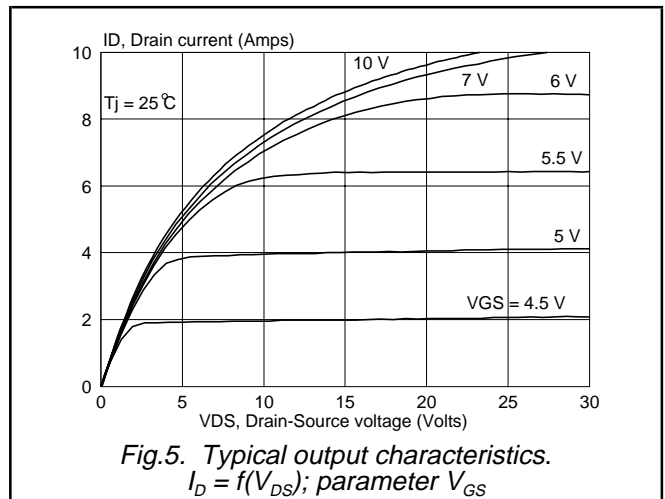
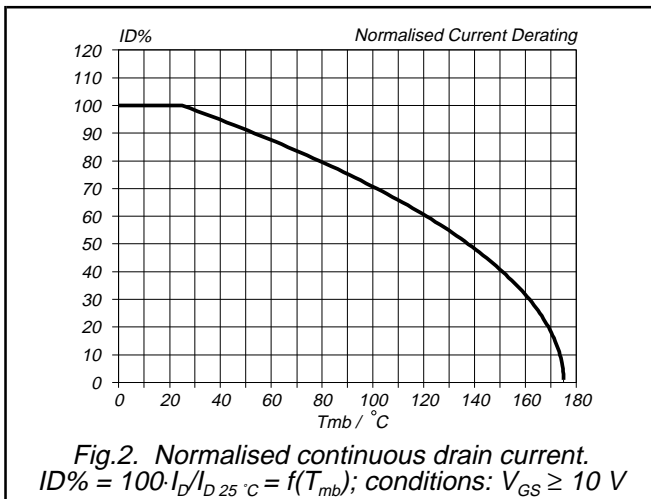
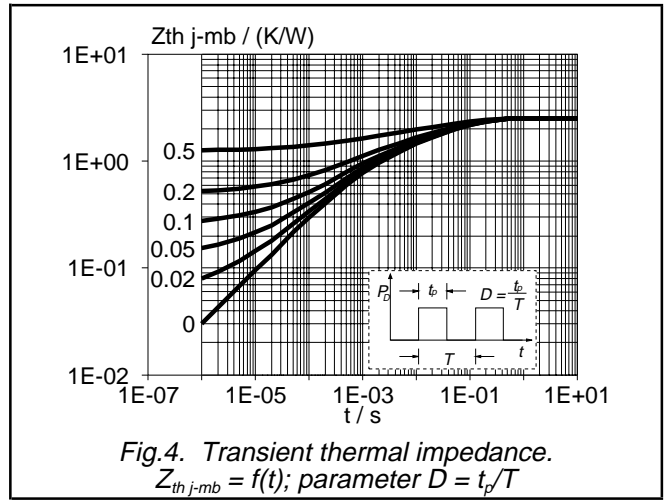
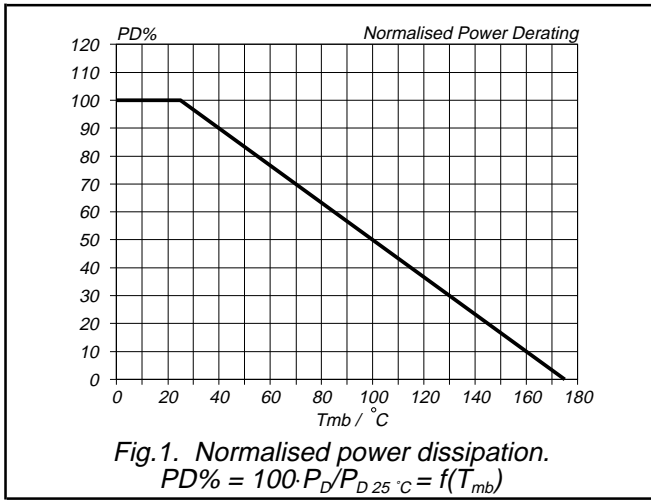
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}; I_D = 0.25\text{ mA}$	200	-	-	V
$\frac{\Delta V_{(BR)DSS}}{\Delta T_j}$	Drain-source breakdown voltage temperature coefficient	$V_{DS} = V_{GS}; I_D = 0.25\text{ mA}$	-	0.25	-	V/K
$R_{DS(ON)}$	Drain-source on resistance	$V_{GS} = 10\text{ V}; I_D = 2.5\text{ A}$	-	0.68	0.9	$\Omega$
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}; I_D = 0.25\text{ mA}$	2.0	3.0	4.0	V
$g_{fs}$	Forward transconductance	$V_{DS} = 50\text{ V}; I_D = 2.5\text{ A}$	1.5	3.5	-	S
$I_{DSS}$	Drain-source leakage current	$V_{DS} = 200\text{ V}; V_{GS} = 0\text{ V}$	-	0.1	25	$\mu\text{A}$
$I_{GSS}$	Gate-source leakage current	$V_{DS} = 160\text{ V}; V_{GS} = 0\text{ V}; T_j = 150\text{ }^\circ\text{C}$ $V_{GS} = \pm 30\text{ V}; V_{DS} = 0\text{ V}$	-	1	250	$\mu\text{A}$
$Q_{g(tot)}$	Total gate charge	$I_D = 4.8\text{ A}; V_{DD} = 160\text{ V}; V_{GS} = 10\text{ V}$	-	11	15	nC
$Q_{gs}$	Gate-source charge		-	2	3	nC
$Q_{gd}$	Gate-drain (Miller) charge		-	5.3	7	nC
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 100\text{ V}; I_D = 4.8\text{ A};$ $R_G = 18\text{ }\Omega; R_D = 20\text{ }\Omega$	-	7	-	ns
$t_r$	Turn-on rise time		-	29	-	ns
$t_{d(off)}$	Turn-off delay time		-	27	-	ns
$t_f$	Turn-off fall time		-	22	-	ns
$L_d$	Internal drain inductance	Measured from tab to centre of die	-	3.5	-	nH
$L_s$	Internal source inductance	Measured from source lead solder point to source bond pad	-	7.5	-	nH
$C_{iss}$	Input capacitance	$V_{GS} = 0\text{ V}; V_{DS} = 25\text{ V}; f = 1\text{ MHz}$	-	300	-	pF
$C_{oss}$	Output capacitance		-	60	-	pF
$C_{rss}$	Feedback capacitance		-	20	-	pF

**SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS** $T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_S$	Continuous source current (body diode)	$T_{mb} = 25\text{ }^\circ\text{C}$	-	-	5	A
$I_{SM}$	Pulsed source current (body diode)	$T_{mb} = 25\text{ }^\circ\text{C}$	-	-	20	A
$V_{SD}$	Diode forward voltage	$I_S = 5.2\text{ A}; V_{GS} = 0\text{ V}$	-	-	1.5	V
$t_{rr}$	Reverse recovery time	$I_S = 4.8\text{ A}; V_{GS} = 0\text{ V};$ $di/dt = 100\text{ A}/\mu\text{s}$	-	114	-	ns
$Q_{rr}$	Reverse recovery charge		-	0.8	-	$\mu\text{C}$

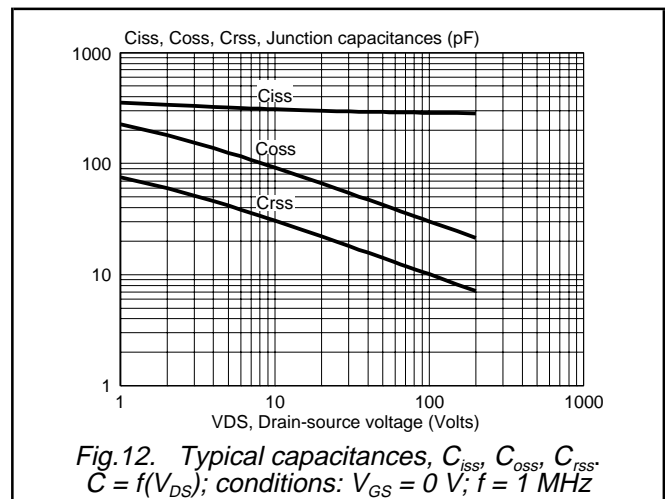
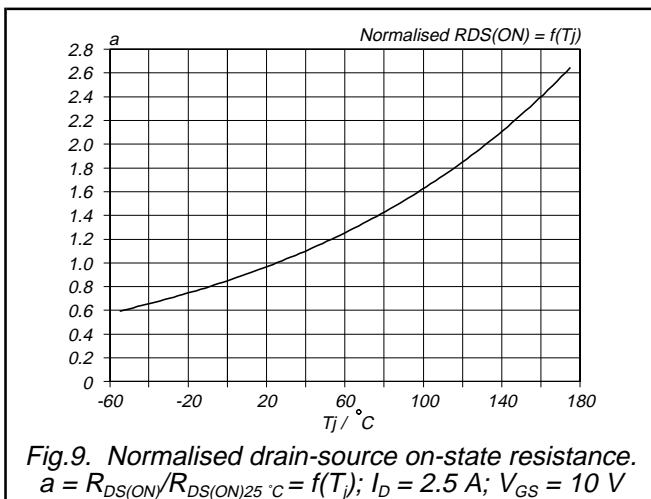
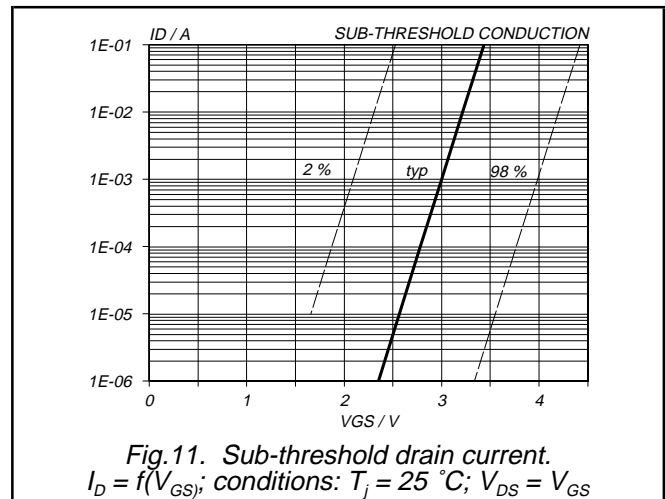
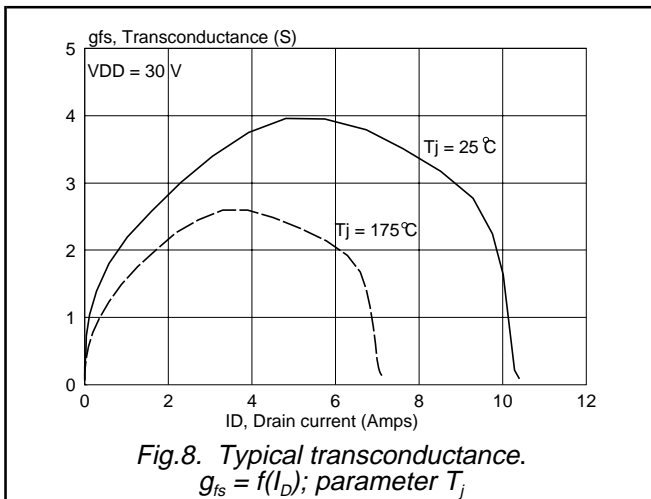
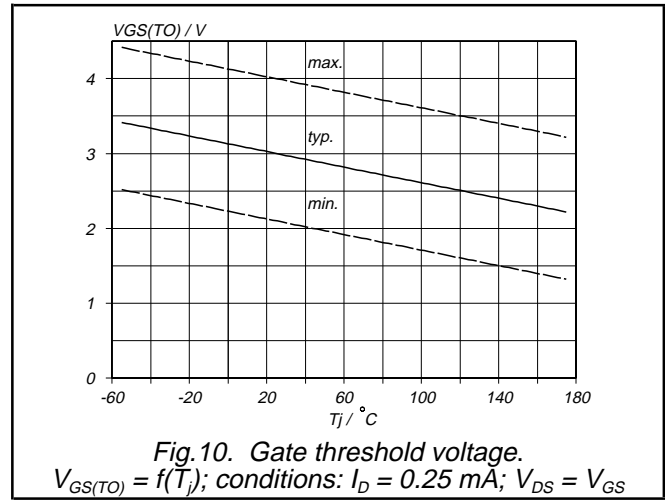
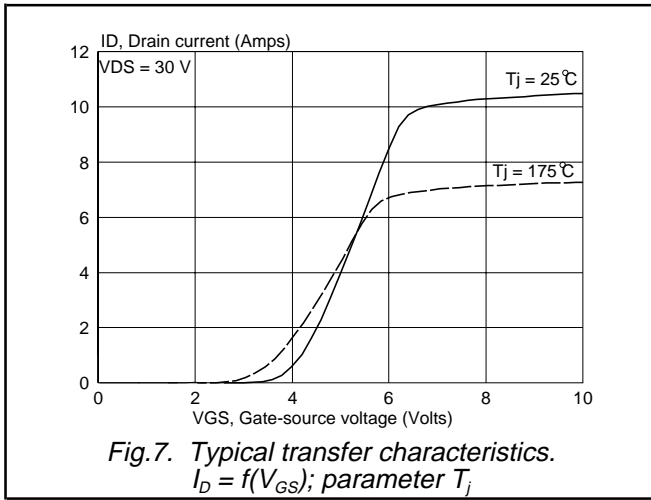
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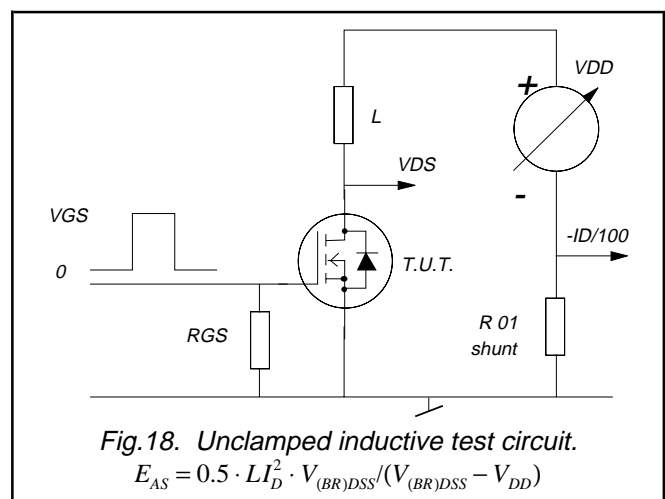
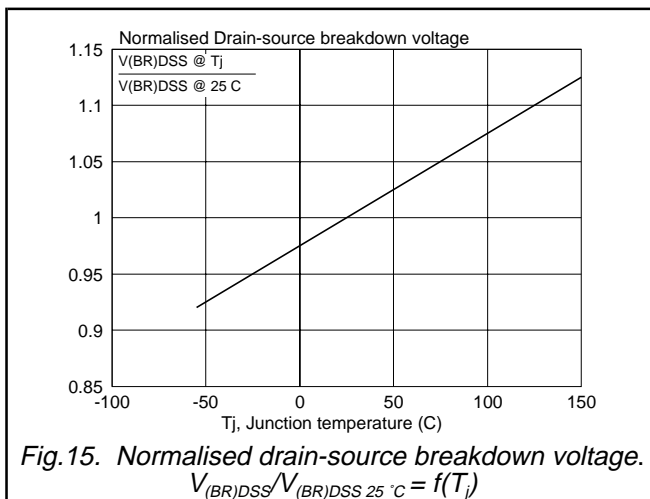
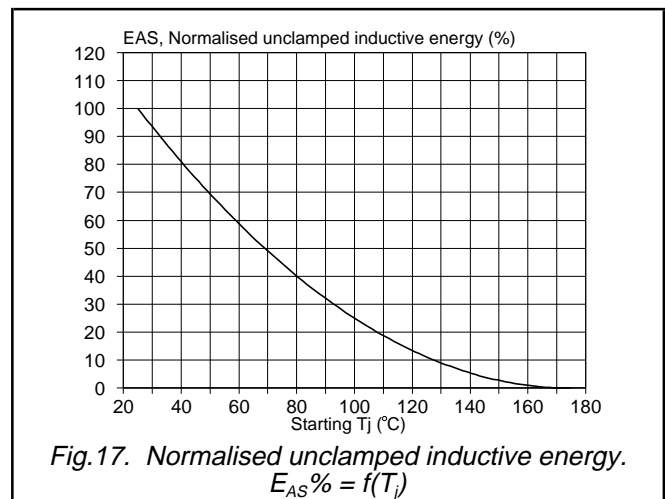
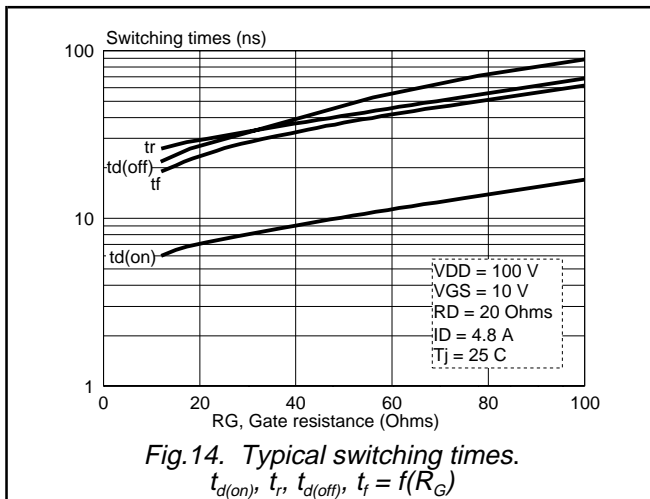
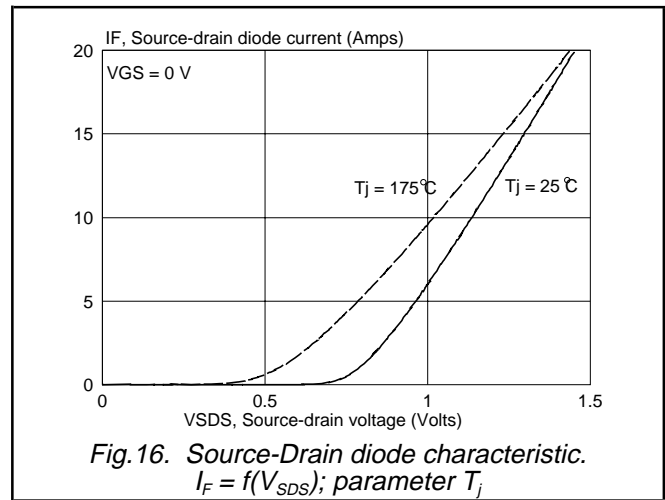
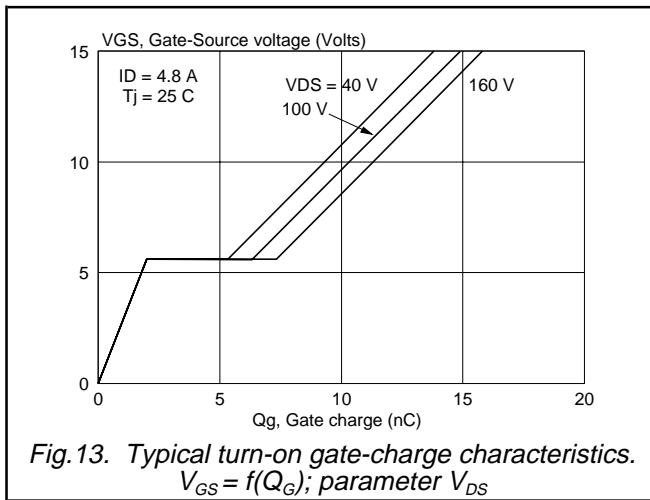
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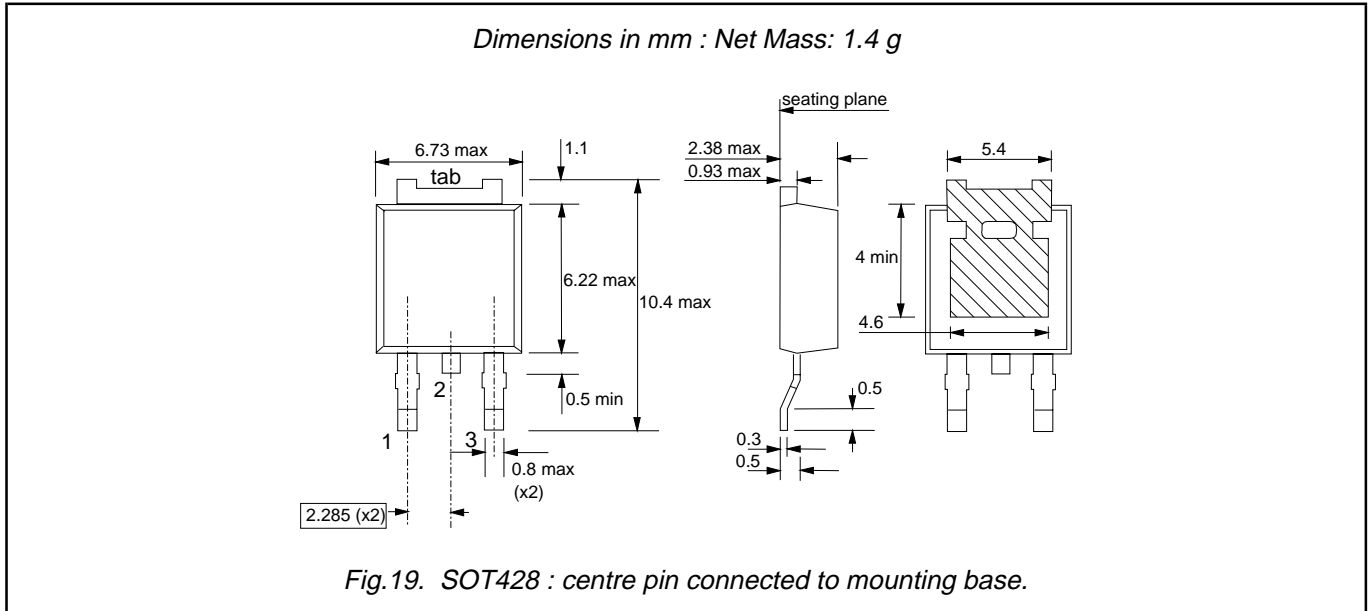


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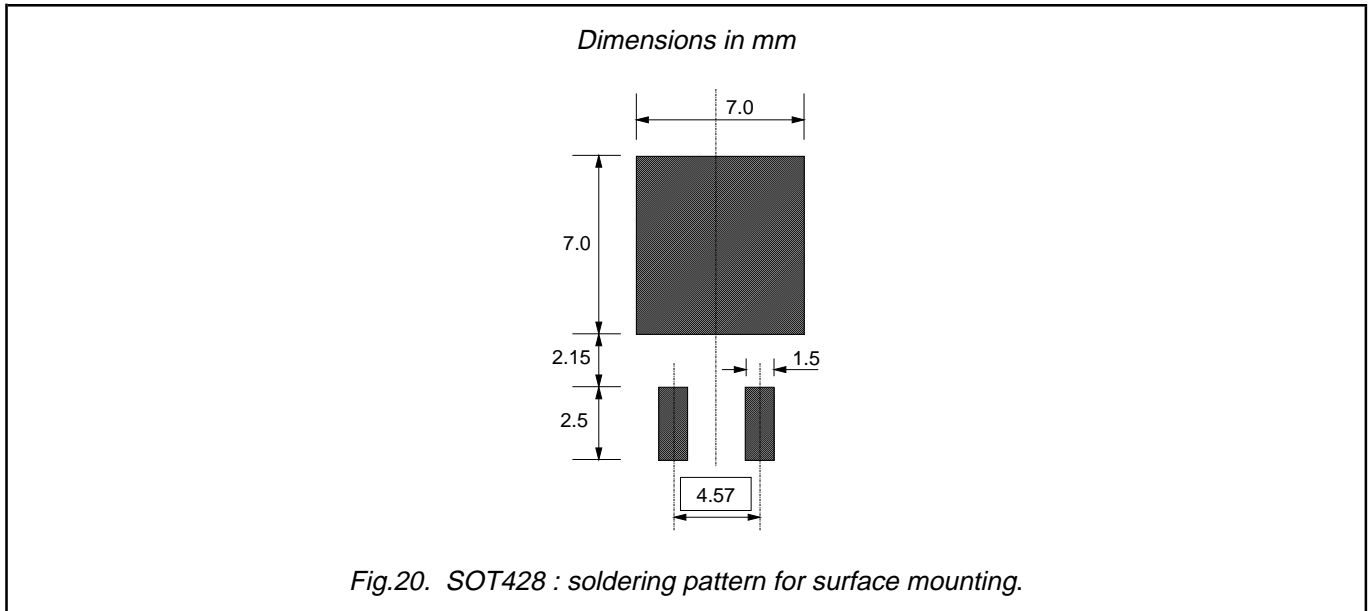
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**MECHANICAL DATA**



**MOUNTING INSTRUCTIONS**



**Notes**

1. Observe the general handling precautions for electrostatic-discharge sensitive devices (ESDs) to prevent damage to MOS gate oxide.
2. Epoxy meets UL94 V0 at 1/8".

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**DEFINITIONS**

<b>Data sheet status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	
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